

# **HD74HC91**

## 8-bit Shift Register

REJ03D0696-0200 (Previous ADE-205-429) Rev.2.00 Oct 06, 2005

## **Description**

This serial-out, 8-bit shift register is composed of eight R-S master-slave flip-flops, input gating, and a clock drive. Single-rail data and input control are gated through inputs A and B and an internal inverter to form the complementary inputs to the first bit of the shift register. Drive for the internal common clock line is provided by an inverting clock driver. This clock pulse inverter/driver causes these circuits to shift information one bit on the positive edge of an input clock pulse.

### **Features**

• High Speed Operation:  $t_{pd}$  (Data Word Input to Output) = 21 ns typ ( $C_L = 50 \text{ pF}$ )

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage:  $V_{CC} = 2$  to 6 V

• Low Input Current: 1 μA max

• Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC91RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

### **Function Table**

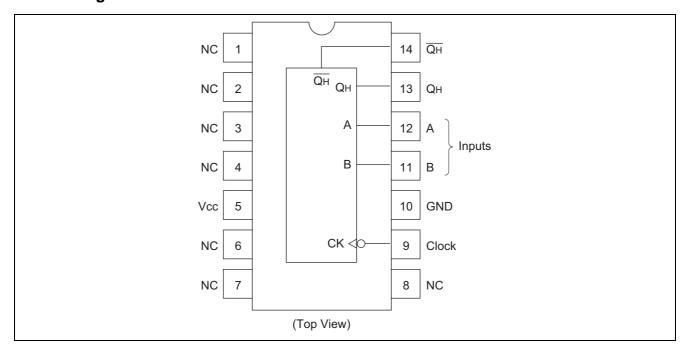
Inpu	Outputs			
t <sub>n</sub>	t <sub>n + 8</sub>			
Α	В	Q <sub>H</sub>	Q <sub>H</sub>	
Н	Н	Н	L	
L	X	L	Н	
X	L	L	Н	

H: High levelL: Low levelX: Irrelevant

t<sub>n</sub>: Reference bit time, clock low

t<sub>n+8</sub>: Bit time after 8 low-to-high clock transitions

## **Pin Arrangement**



## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
Input / Output voltage	Vin, Vout	-0.5 to V <sub>CC</sub> +0.5	V
Input / Output diode current	I <sub>IK</sub> , I <sub>OK</sub>	±20	mA
Output current	I <sub>0</sub>	±25	mA
V <sub>CC</sub> , GND current	I <sub>CC</sub> or I <sub>GND</sub>	±50	mA
Power dissipation	P <sub>T</sub>	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

## **Recommended Operating Conditions**

Item	Symbol Ratings		Unit	Conditions
Supply voltage	Vcc	2 to 6	V	
Input / Output voltage	V <sub>IN</sub> , V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V <sub>CC</sub> = 2.0 V
Input rise / fall time*1	t <sub>r</sub> , t <sub>f</sub>	0 to 500	ns	V <sub>CC</sub> = 4.5 V
		0 to 400		V <sub>CC</sub> = 6.0 V

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

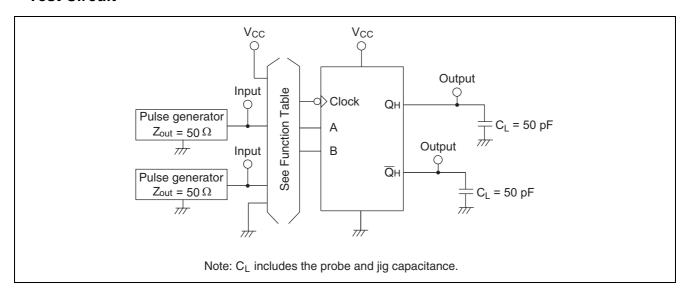
## **Electrical Characteristics**

			Т	a = 25°	С	Ta = -40	to+85°C			
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Cor	ditions
Input voltage	V <sub>IH</sub>	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_			
	$V_{IL}$	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -5.2 \text{ mA}$
	V <sub>OL</sub>	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} or V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	_	0.0	0.1	_	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33			$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26	_	0.33			$I_{OL} = 5.2 \text{ mA}$
Input current	lin	6.0		_	±0.1		±1.0	μΑ	$Vin = V_{CC}$ or $GN$	D
Quiescent supply current	Icc	6.0	_	_	4.0	_	40	μА	Vin = V <sub>CC</sub> or GN	D, lout = 0 μA

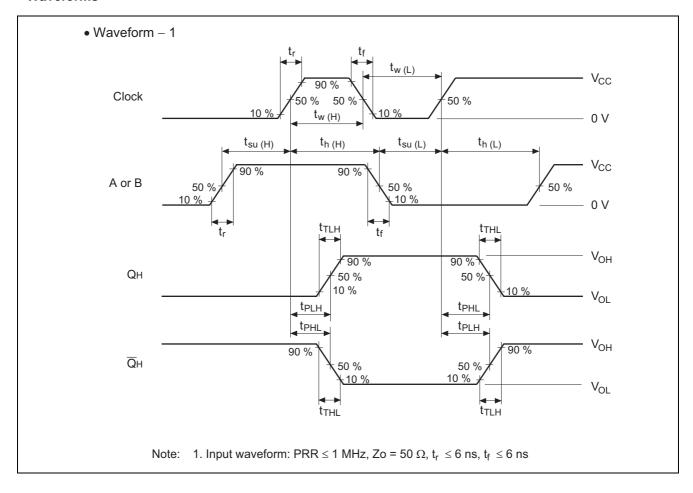
# Switching Characteristics ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ ns}$ )

			Т	a = 25°	°C Ta = -40 to +85°C				
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f <sub>max</sub>	2.0	_		5	_	4	MHz	
frequency		4.5	_	_	25	_	20		
		6.0	_	_	29	_	24		
Propagation delay	t <sub>PLH</sub>	2.0	_	_	210	_	265	ns	
time		4.5	_	21	42	_	53		
		6.0	_	_	36	_	45		
	t <sub>PHL</sub>	2.0	_	_	210	_	265	ns	
		4.5	_	21	42	_	53		
		6.0	_	_	36	_	45		
Pulse width	t <sub>w</sub>	2.0	125	_	_	156	_	ns	Clock
		4.5	25	9	_	31	_		
		6.0	21	_	_	26	_		
Setup time	t <sub>su</sub>	2.0	125	_	_	156	_	ns	
		4.5	25	1	_	31	_		
		6.0	21	_	_	26	_		
Hold time	t <sub>h</sub>	2.0	5	_	_	5	_	ns	
		4.5	5	-1	_	5	_		
		6.0	5	_	_	5	_		
Output rise/fall	t <sub>TLH</sub> , t <sub>THL</sub>	2.0	l		75	_	95	ns	
time		4.5	l	5	15		19		
		6.0	l		13		16		
Input capacitance	Cin	_	_	5	10	_	10	pF	

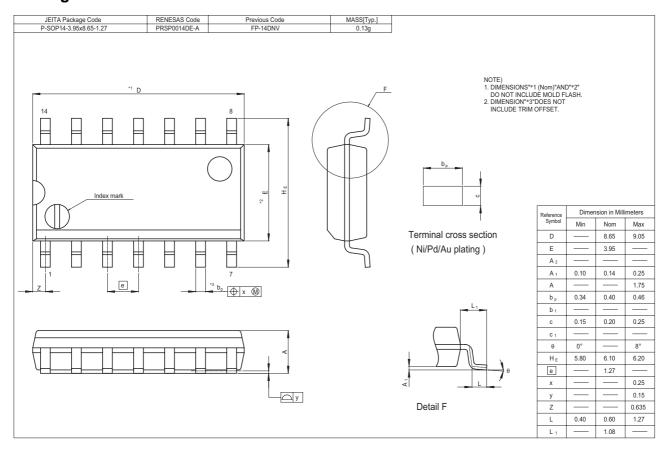
## **Test Circuit**



### **Waveforms**



## **Package Dimensions**



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